

ULTRA LOW CAPACITANCE ESD PROTECTION COMPONENT

DESCRIPTION

The P0201V05 is an ultra low capacitance ESD component designed to protect very high-speed data interfaces. The device has a typical capacitance of only 0.15pF (I/O to GND) and is compatible with the ESD immunity requirements of IEC61000-4-2.

FEATURES

- Compatible with IEC 61000-4-2 (ESD): Air 15kV (Typical), 25kV(Max)
- Compatible with IEC 61000-4-2 (ESD): Contact 8kV (Typical), 15kV(Max)
- Low Leakage Current: 0.10μA
- Fast Response Time
- Protects One Bidirectional Line
- Ultra Low Capacitance: 0.15 pF (Typical)
- · RoHS Compliant
- REACH Compliant

MECHANICAL CHARACTERISTICS

- Molded Ceramic 0201 Package
- Approximate Weight: 0.22 milligrams
- Lead-Free Plating
- Solder Reflow Temperature:
- Lead-Free Sn/Ag/Cu, 96/3.5/0.5: 260-270°C
- 8mm Tape and Reel Per EIA Standard 481
- Flammability Rating UL 94V-0

APPLICATIONS

- HDMI
- DVI
- Display Port
- Unified Display Interface (UDI)
- Mobile Display Digital Interface (MDDI)
- Gigabit Ethernet
- USB2.0 & USB3.0
- IEEE 1394 Interface

PIN CONFIGURATION



TYPICAL DEVICE CHARACTERISTICS

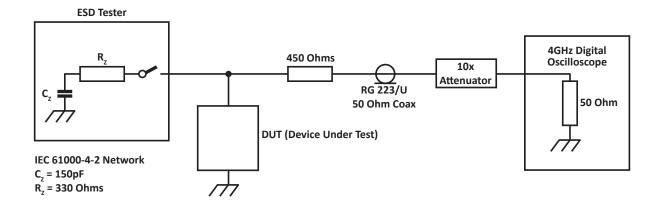
MAXIMUM RATINGS @ 25°C Unless Otherwise Specified							
PARAMETER	SYMBOL	VALUE	UNITS				
Operating Temperature	T _A	-40 to 90	°C				
Storage Temperature	T _{stg}	-55 to 125	°C				
Solder Temperature - 10s	T _L	260	°C				

ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified							
PART NUMBER	RATED STAND-OFF VOLTAGE	TYPICAL TRIGGER VOLTAGE (Note 1)	MAXIMUM LEAKAGE CURRENT (Note 2)	TYPICAL CAPACITANCE			
	V _{wM} VOLTS	V _T VOLTS	V _c VOLTS	@V _{wм} Ι _D μΑ	@0V, 1MHz C _, pF		
P0201V05	5.0	400	40.0	0.10	0.15		

NOTES

- 1. Trigger and Clamping Voltage are measured per IEC 61000-4-2, 8kV contact discharge method.
- 2. After reliability tests such as high temperature storage, temp cycle, continuous ESD strikes, the maximum leakage current is less than 10µA.

FIGURE 1 ESD CLAMPING TEST



TYPICAL DEVICE CHARACTERISTICS

FIGURE 2
TYPICAL ESD WAVEFORM

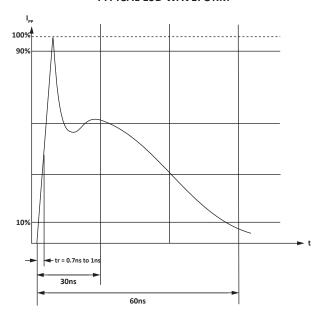


FIGURE 3
ESD WAVE AFTER CLAMPING



SOLDER REFLOW INFORMATION

PRINTED CIRCUIT BOARD RECOMMENDATIONS						
PARAMETER	VALUE					
Pad Size on PCB	0.275mm					
Pad Shape	Round					
Pad Definition	Non-Solder Mask Defined Pads					
Solder Mask Opening	0.325mm Round					
Solder Stencil Thickness	0.150mm					
Solder Stencil Aperture Opening (Laser cut, 5% tapered walls)	0.330mm Round					
Solder Paste Type	No Clean					
Pad Protective Finish	OSP (Entek Cu Plus 106A)					
Tolerance - Edge To Corner Ball	±50μm					
Solder Ball Side Coplanarity	±20μm					
Maximum Dwell Time Above Liquidous (183°C)	60 seconds					
Soldering Maximum Temperature	270°C					

REQUIREMENTS

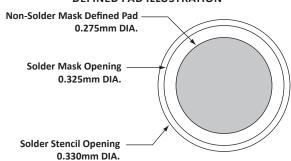
Temperature:

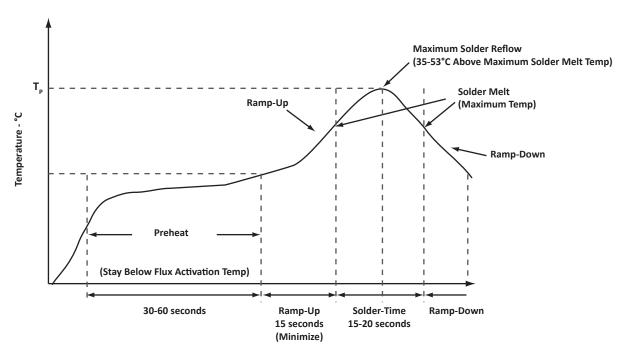
 $T_{_{D}}$ for Lead-Free (Sn/Ag/Cu): 260-270°C

T_p for Tin-Lead: 240-245°C

Preheat time and temperature depends on solder paste and flux activation temperature, component size, weight, surface area and plating.

RECOMMENDED NON-SOLDER MASK DEFINED PAD ILLUSTRATION



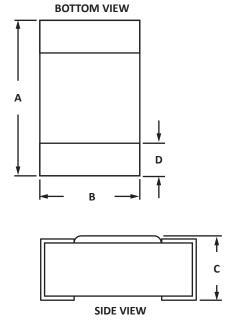




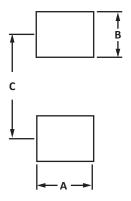
C0201 PACKAGE INFORMATION

1. Controlling dimension: millimeters.

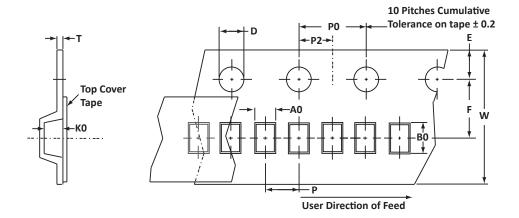
OUTLINE DIMENSIONS							
DIM	MILLIN	IETERS	INCHES				
DIM	MIN	MAX	MIN	MAX			
А	0.50	0.70	0.020	0.028			
В	0.25	0.35	0.010	0.014			
С	0.25	0.40	0.010	0.016			
D	0.10	0.30	0.004	0.012			
NOTES							



PAD LAYOUT DIMENSIONS						
DIM	MILLIMETERS	INCHES				
DIM	NOM	NOM				
Α	0.30	0.012				
В	0.25	0.010				
C 0.60 0.024						
NOTES 1. Controlling dimension: millimeters						



TAPE AND REEL



SPECIFICATIONS												
REEL DIA.	TAPE WIDTH	A0	В0	ко	D	E	F	w	P0	P2	Р	tmax
178mm (7")	8mm	0.75 ± 0.05	1.22 ± 0.10	0.56 ± 0.05	1.55 ± 0.10	1.75 ± 0.10	3.50 ± 0.05	8.00 ± 0.30	4.00 ± 0.10	2.00 ± 0.05	2.00 ± 0.05	0.25

NOTES

- 1. Dimensions are in millimeters.
- 2. Surface mount product is taped and reeled in accordance with EIA-481.
- 3. Suffix T710 = 7" Reel 10,000 pieces per 8mm tape.

ORDERING INFORMATION							
BASE PART NUMBER	LEADFREE SUFFIX	TAPE SUFFIX	QTY/REEL	REEL SIZE	TUBE QTY		
P0201V05 N/A -T710		-T710	10,000	7"	N/A		
This device is only available in a Lead-Free configuration.							

05393.R0 11/12 Page 6 <u>www.protekdevices.com</u>



COMPANY INFORMATION

COMPANY PROFILE

In business more than 20 years, ProTek Devices™ is a privately-held company located in Tempe, Arizona, that offers a product line of transient voltage suppressors (TVS); avalanche breakdown diodes; steering diode TVS arrays and other surge suppressor component products. These TVS devices protect electronic systems from the effects of lightning, electrostatic discharge (ESD), nuclear electromagnetic pulses (NEMP), inductive switching and EMI / RFI. ProTek Devices also offers high performance interface and linear products that include analog switches; multiplexers; LED drivers; audio control ICs; RF and related high frequency products. The analog devices work in a host of consumer; industrial; automotive and other applications.

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